






## Features

- Fast tripping resettable circuit protection
- Surface mount packaging for automated assembly
- Small footprint size (1210)
- RoHS compliant\*
- Agency recognition\*:   

## Applications

- Game consoles
- PC motherboards
- USB current-limiting compliance
- IEEE 1394 ports
- Mobile phones
- Digital cameras

# MF-USMF Series - PTC Resettable Fuses

## Electrical Characteristics

Model	V max. Volts	I max. Amps	I <sub>hold</sub>	I <sub>trip</sub>	Resistance		Max. Time To Trip		Tripped Power Dissipation
			Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C
			Hold	Trip	R <sub>Min.</sub>	R <sub>1Max.</sub>			Typ.
MF-USMF005	30	10	0.05	0.15	2.800	50.000	0.25	1.50	0.6
MF-USMF010	30	10	0.10	0.30	0.800	15.000	0.50	0.60	0.6
MF-USMF020	30	10	0.20	0.40	0.400	5.000	8.00	0.02	0.6
MF-USMF035	6	40	0.35	0.75	0.200	1.300	8.00	0.20	0.6
MF-USMF050	13.2	40	0.50	1.00	0.180	0.900	8.00	0.10	0.6
MF-USMF075	6	40	0.75	1.50	0.070	0.450	8.00	0.10	0.6
MF-USMF110	6	40	1.10	2.20	0.050	0.210	5.00	1.00	0.6
MF-USMF150	6	40	1.50	3.00	0.030	0.110	5.00	5.00	0.6
MF-USMF175X*	6	40	1.75	3.50	0.020	0.090	8.00	1.00	0.7

\* CSA approval pending.

## Environmental Characteristics

Operating Temperature .....	-40 °C to +85 °C
Maximum Device Surface Temperature	
in Tripped State .....	125 °C
Passive Aging.....	+85 °C, 1000 hours .....±5 % typical resistance change
Humidity Aging.....	+85 °C, 85 % R.H. 1000 hours .....±5 % typical resistance change
Thermal Shock .....	+85 °C to -40 °C, 20 times .....±10 % typical resistance change
Solvent Resistance .....	MIL-STD-202, Method 215 .....No change
Vibration .....	MIL-STD-883C, Method 2007.1, .....No change Condition A

## Test Procedures And Requirements For Model MF-USMF Series

Test	Test Conditions	Accept/Reject Criteria
Visual/Mech.....	Verify dimensions and materials .....	Per MF physical description
Resistance .....	In still air @ 23 °C.....	R <sub>min</sub> ≤ R ≤ R <sub>1max</sub>
Time to Trip .....	At specified current, V <sub>max</sub> , 23 °C .....	T ≤ max. time to trip (seconds)
Hold Current .....	30 min. at I <sub>hold</sub> .....	No trip
Trip Cycle Life .....	V <sub>max</sub> , I <sub>max</sub> , 100 cycles .....	No arcing or burning
Trip Endurance.....	V <sub>max</sub> , 48 hours .....	No arcing or burning
Solderability .....	ANSI/J-STD-002 .....	95 % min. coverage
UL File Number .....	E174545 <a href="http://www.ul.com/">http://www.ul.com/</a> Follow link to Certifications, then UL File No., enter E174545	
CSA File Number .....	CA110338 <a href="http://directories.csa-international.org/">http://directories.csa-international.org/</a> Under "Certification Record" and "File Number" enter 110338-0-000	
TÜV Certificate Number .....	R 02057213 <a href="http://www.tuvdotcom.com/">http://www.tuvdotcom.com/</a> Follow link to "other certificates", enter File No. 2057213	

\*RoHS Directive 2002/95/EC Jan 27 2003 including Annex Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

# MF-USMF Series - PTC Resettable Fuses

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## Product Dimensions

Model	A		B		C		D
	Min.	Max.	Min.	Max.	Min.	Max.	Min.
MF-USMF005	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.80}{(0.031)}$	$\frac{1.1}{(0.043)}$	$\frac{0.30}{(0.012)}$
MF-USMF010	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.80}{(0.031)}$	$\frac{1.1}{(0.043)}$	$\frac{0.30}{(0.012)}$
MF-USMF020	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.80}{(0.031)}$	$\frac{1.1}{(0.043)}$	$\frac{0.30}{(0.012)}$
MF-USMF035	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF050	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF075	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF110	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.55}{(0.022)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF150	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.40}{(0.016)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$
MF-USMF175X	$\frac{3.00}{(0.118)}$	$\frac{3.43}{(0.135)}$	$\frac{2.35}{(0.093)}$	$\frac{2.80}{(0.110)}$	$\frac{0.40}{(0.016)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$

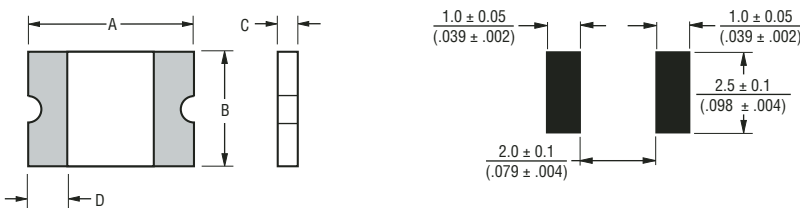
Packaging: 3000 pcs. per reel.

UNIT =  $\frac{\text{MM}}{\text{(INCHES)}}$

Top and Bottom View

Side View

Recommended Pad Layout



### Terminal material:

Electroless Ni under immersion Au

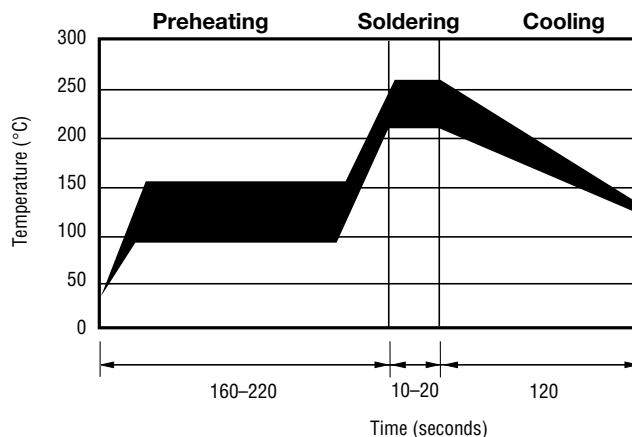
### Termination pad solderability:

Standard Au finish:  
Meets ANSI/J-STD-002 Category 2.

### Recommended Storage:

40 °C max./70 % RH max.

## Solder Reflow Recommendations



### Notes:

- MF-USMF models cannot be wave soldered.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Compatible with Pb and Pb-free solder reflow profiles.

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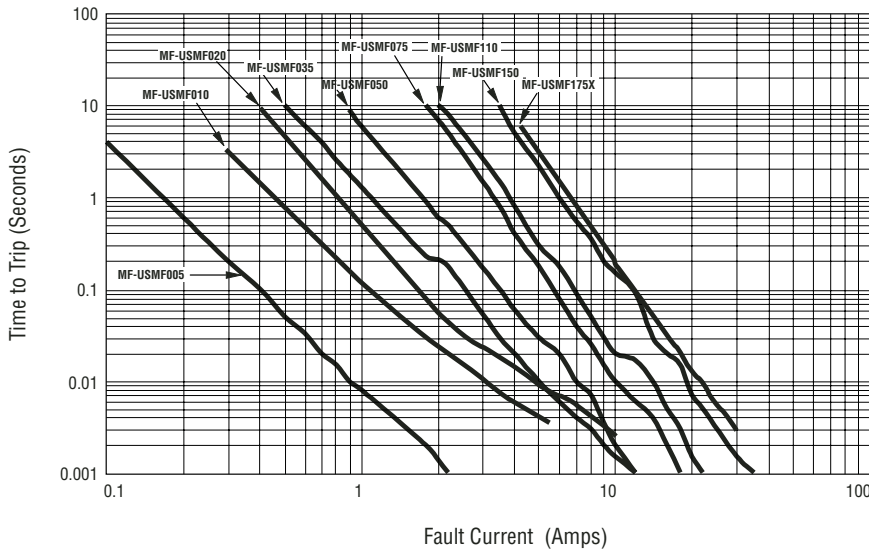
# MF-USMF Series - PTC Resettable Fuses

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Thermal Derating Chart -  $I_{hold}$  (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-USMF005	0.08	0.07	0.06	0.05	0.04	0.04	0.03	0.03	0.02
MF-USMF010	0.15	0.13	0.12	0.10	0.09	0.08	0.07	0.06	0.05
MF-USMF020	0.32	0.28	0.24	0.20	0.18	0.16	0.14	0.12	0.10
MF-USMF035	0.51	0.46	0.40	0.34	0.30	0.27	0.24	0.22	0.18
MF-USMF050	0.76	0.66	0.58	0.48	0.42	0.38	0.35	0.29	0.23
MF-USMF075	1.10	0.97	0.86	0.72	0.64	0.58	0.55	0.47	0.39
MF-USMF110	1.60	1.42	1.26	1.10	0.94	0.86	0.80	0.70	0.58
MF-USMF150	2.30	2.02	1.76	1.43	1.24	1.11	1.00	0.85	0.65
MF-USMF175X	2.80	2.45	2.10	1.75	1.55	1.45	1.35	1.25	1.10

Typical Time to Trip at 23 °C



The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

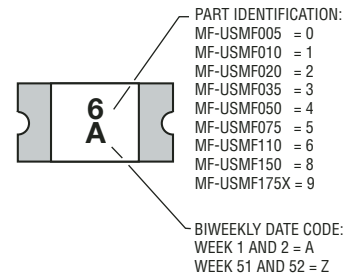
### How to Order

**MF - USMF 010 X - 2**

Multifuse® Product  
 Designator \_\_\_\_\_  
 Series \_\_\_\_\_  
 USMF = 1210 Surface Mount Component  
 Hold Current,  $I_{hold}$  \_\_\_\_\_  
 005-175 (0.05-1.75 Amps)  
 Expansion Free Design \_\_\_\_\_  
 Packaging \_\_\_\_\_  
 Packaged per EIA 481-1  
 -2 = Tape and Reel

### Typical Part Marking

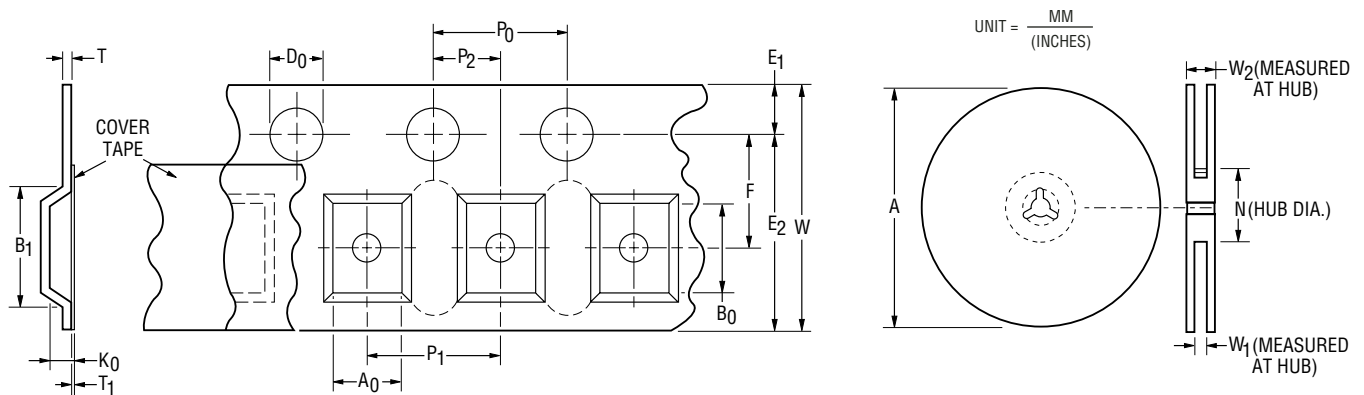
Represents total content. Layout may vary.



# MF-USMF Series Tape and Reel Specifications

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Tape Dimensions	MF-USMF Series per EIA 481-2
W	$\frac{8.0 \pm 0.3}{(0.315 \pm 0.012)}$
P <sub>0</sub>	$\frac{4.0 \pm 0.1}{(0.157 \pm 0.004)}$
P <sub>1</sub>	$\frac{4.0 \pm 0.1}{(0.157 \pm 0.004)}$
P <sub>2</sub>	$\frac{2.0 \pm 0.05}{(0.079 \pm 0.002)}$
A <sub>0</sub>	$\frac{2.76 \pm 0.10}{(0.109 \pm 0.004)}$
B <sub>0</sub>	$\frac{3.50 \pm 0.10}{(0.138 \pm 0.004)}$
B <sub>1</sub> max.	$\frac{4.35}{(0.171)}$
D <sub>0</sub>	$\frac{1.5 + 0.1/-0.0}{(0.059 + 0.004/-0)}$
F	$\frac{3.5 \pm 0.05}{(0.138 \pm 0.002)}$
E <sub>1</sub>	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
E <sub>2</sub> min.	$\frac{6.25}{(0.246)}$
T max.	$\frac{0.6}{(0.024)}$
T <sub>1</sub> max.	$\frac{0.1}{(0.004)}$
K <sub>0</sub>	$\frac{1.07 \pm 0.10}{(0.042 \pm 0.004)}$
Leader min.	$\frac{390}{(15.35)}$
Trailer min.	$\frac{160}{(6.30)}$
Reel Dimensions	
A max.	$\frac{185}{(7.283)}$
N min.	$\frac{50}{(1.97)}$
W <sub>1</sub>	$\frac{8.4 + 1.5/-0.0}{(0.331 + 0.059/-0.0)}$
W <sub>2</sub> max.	$\frac{14.4}{(0.567)}$



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